CAUTION: These Devices are Sensitive to Electrostatic Discharge. Proper Handling Procedures Should Be Followed.

# **FEATURES**

- Improved Ruggedness V<sub>(BR)DSS</sub> = 130V
- 150W with 22dB Typical Gain @ 30MHz, 50V
- 150W with 14dB Typical Gain @ 175MHz, 50V
- Excellent Stability & Low IMD
- Common Source Configuration
- Available in Matched Pairs

Maximum Patings

Maximum Rai	ings All Ratings. 1 <sub>c</sub> =23	All Ratings. 1 <sub>c</sub> = 25 C unless otherwise specifie			
Symbol	Parameter	VRF152(MP)	Unit		
$V_{\rm dss}$	Drain-Source Voltage	130	V		
I <sub>D</sub>	Continuous Drain Current @ T <sub>c</sub> = 25°C	20	А		
V <sub>GS</sub>	Gate-Source Voltage	±40	V		
P <sub>D</sub>	Total Device dissipation @ $T_c$ = 25°C	300	W		
T <sub>STG</sub>	Storage Temperature Range	-65 to 150	°C		
L	Operating Junction Temperature	200			

Nitride Passivated

RoHS Compliant

· Refractory Gold Metallization

### **Static Electrical Characteristics**

Symbol	Parameter	Min	Тур	Мах	Unit
$V_{(BR)DSS}$	Drain-Source Breakdown Voltage ( $V_{GS} = 0V$ , $I_{D} = 50mA$ )	130			V
R <sub>DS(ON)</sub>	Drain-Source On-State Resistance $^{1}$ (V <sub>GS</sub> = 10V, I <sub>D</sub> = 10A)		0.13	0.20	Ohms
I <sub>DSS</sub>	Zero Gate Voltage Drain Current ( $V_{DS}$ = 50V, $V_{GS}$ = 0V)			50	μA
I <sub>GSS</sub>	Gate-Source Leakage Current ( $V_{GS} = \pm 20V$ , $V_{DS} = 0V$ )			1.0	μA
9 <sub>fs</sub>	Forward Transconductance ( $V_{DS}$ = 10V, $I_{D}$ = 5A)	5.0	6.2		mhos
V <sub>GS(TH)</sub>	Gate Threshold Voltage ( $V_{DS}$ = 10V, $I_{D}$ = 100mA)	2.9	3.6	4.4	V

## **Thermal Characteristics**

Ĩ	Symbol	Characteristic	Min	Тур	Max	Unit
	R <sub>θJC</sub>	Junction to Case Thermal Resistance			0.60	°C/W

Microsemi Website - http://www.microsemi.com

All Patings: T =25°C unloss otherwise specified

• 70:1 Load VSWR Capability at Specified Operating Conditions

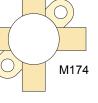
· Low Rds Replacement for MRF151/ BLF177/ SD2941

The VRF152 is a gold-metallized silicon n-channel RF power transistor designed for broadband commercial and military applications requiring high power and gain without compromising reliability, ruggedness, or inter-modulation distortion.

# **RF POWER VERTICAL MOSFET**

**Sicrosemi**,

## 50V, 150W, 175MHz



# VRF152 VRF152MP

### **Dynamic Characteristics**

VRF152(MP)

Symbol	Parameter	Test Conditions	Min	Тур	Max	Unit
C <sub>ISS</sub>	Input Capacitance	V <sub>GS</sub> = 0V		383		
C <sub>oss</sub>	Output Capacitance	V <sub>DS</sub> = 50V		215		pF
C <sub>rss</sub>	Reverse Transfer Capacitance	f = 1MHz		20		

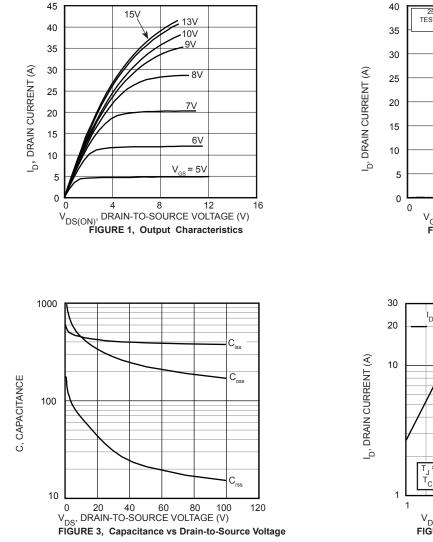
## **Functional Characteristics**

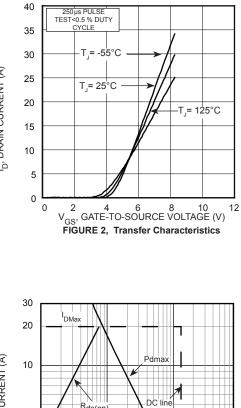
Symbol	Parameter	Min	Тур	Max	Unit
G <sub>PS</sub>	$f_1 = 30MHz$ , $f_2 = 30.001MHz$ , $V_{DD} = 50V$ , $I_{DQ} = 250mA$ , $P_{out} = 150W_{PEP}^{-1}$	18	22		dB
G <sub>PS</sub>	f = 175MHz, V <sub>DD</sub> = 50V, I <sub>DQ</sub> = 250mA, P <sub>out</sub> = 150W		14		uв
η <sub>D</sub>	$f_1 = 30MHz, f_2 = 30.001MHz, V_{DD} = 50V, I_{DQ} = 250mA, P_{out} = 150W_{PEP}^{-1}$		50		%
IMD <sub>(d3)</sub>	$f_1 = 30MHz$ , $f_2 = 30.001MHz$ , $V_{DD} = 50V$ , $I_{DQ} = 250mA$ , $P_{out} = 150W_{PEP}^{-1}$		-30		dBc
Ψ	f = 30MHz, $V_{_{DD}}$ = 50V, $I_{_{DQ}}$ = 250mA, $P_{_{out}}$ = 150W CW 70:1 VSWR - All Phase Angles, 0.2mSec X 20% Duty Factor	No Degradation in Output Power		Power	

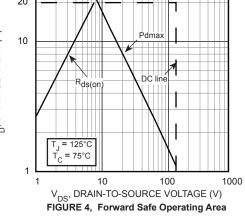
1. To MIL-STD-1311 Version A, test method 2204B, Two Tone, Reference Each Tone

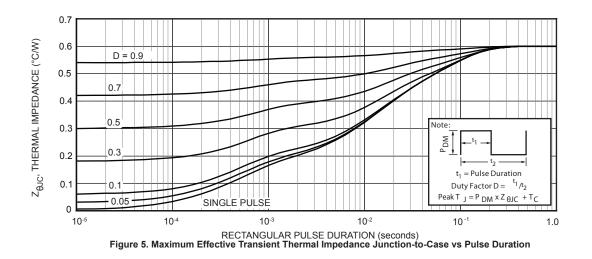
Microsemi reserves the right to change, without notice, the specifications and information contained herein.

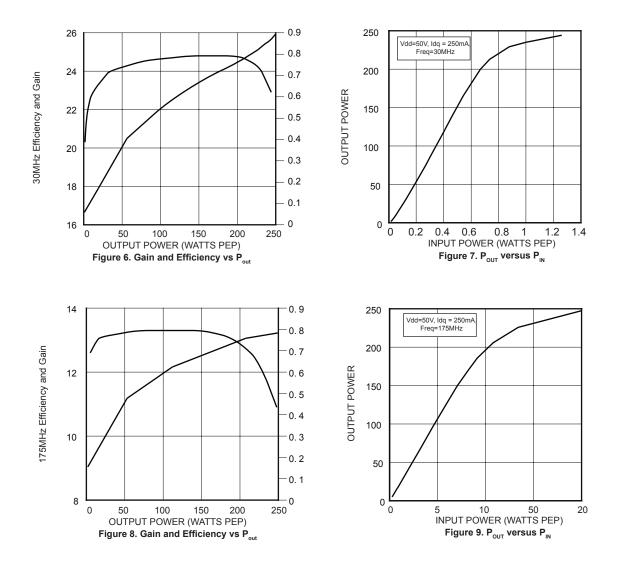
### **Typical Performance Curves**

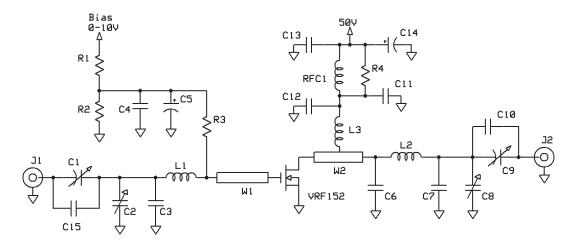






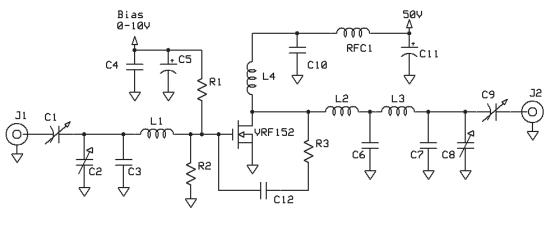






C1,2,8,9 - ARCO 463 20-180pF C3,7 - 120 pF ATC 100B C4,11-13 - 0.1uF 100Y SMT C5 - 1 uF 15WV tant C6, C15 - 47pF ATC 100B C10 - 150pF ATC 100B C14 - 15uF 100Y Elect W1 W2 - printed line 0.23"x 0.7" L1 - 4t #20 ga .25"d x .16"L ~120nH L2 - 5t #14 ga .312" dia x .45" ~135nH L3 -7 turns #16 ga 5/16" ID tight. ~250nH R1 R2 - 2.2k ohm 1/4W R3 - 22 ohm 1W SMT R4 - 2.2 ohm 2W RFC1 Fair-Rite 2961666631 (VK200-4B) PCB = FR-4 fiberglass-epoxy er = 4.6

### 175 MHz test Circuit



C1 C2 C8 - ARCO 463 C3 C7 - 25 pF ATC 100B C4 C10 C12 - 0.1uF 100Y SMT C5 - 1 uF 15WY tant C6 - 250 pF ATC 100B C9 - ARCO 462 C11 - 15uF 100Y Elect

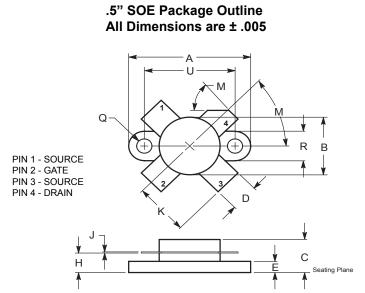
```
L1 - 3/4" #18 ga into Hairpin
L2 - printed line 0.2"W x 0.5" L
L3 - 1" #16 ga into Hairpin
L4 -2 turns #16 ga. 5/16" ID
R1 R2 - 150 ohm 1W
R3 - 470 ohm 3W, Panasonic ECG
RFC1 Fair-Rite 2961666631 (VK200-4B)
```

Downloaded from: http://www.datasheetcatalog.com/

Adding MP at the end of P/N specifies a matched pair where  $V_{GS(TH)}$  is matched between the two parts.  $V_{TH}$  values are marked on the devices per the following table.

Code	Vth Range	Code 2	Vth Range
А	2.900 - 2.975	М	3.650 - 3.725
В	2.975 - 3.050	N	3.725 - 3.800
С	3.050 - 3.125	Р	3.800 - 3.875
D	3.125 - 3.200	R	3.875 - 3.950
E	3.200 - 3.275	S	3.950 - 4.025
F	3.275 - 3.350	Т	4.025 - 4.100
G	3.350 - 3.425	W	4.100 - 4.175
Н	3.425 - 3.500	Х	4.175 - 4.250
J	3.500 - 3.575	Y	4.250 - 4.325
К	3.575 - 3.650	Z	4.325 - 4.400

 $V_{_{TH}}$  values are based on Microsemi measurements at datasheet conditions with an accuracy of 1.0%.



DIM	INCHES		MILLIMETERS		
Divi	MIN	MAX	MIN	MAX	
A	0.096	0.990	24.39	25.14	
В	0.465	0.510	11.82	12.95	
С	0.229	0.275	5.82	6.98	
D	0.216	0.235	5.49	5.96	
E	0.084	0.110	2.14	2.79	
н	0.144	0.178	3.66	4.52	
J	0.003	0.007	0.08	0.17	
к	0.435		11.0		
М	45° I	NOM	45° NOM		
Q	0.115	0.130	2.93	3.30	
R	0.246	0.255	6.25	6.47	
U	0.720	0.730	18.29	18.54	

050-4950 Rev D 3-2016

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